

# MJ N-Channel Enhancement Mode Power MOSFET

## Description

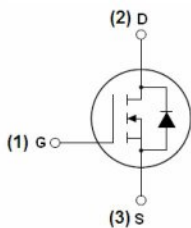
The MJ0130KA uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

## General Features

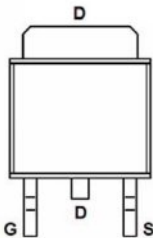
- ◆  $V_{DS} = 100V, I_D = 30A$   
 $R_{DS(ON)} < 32m\Omega @ V_{GS} = 10V$  (Typ:25m $\Omega$ )
- ◆ Special process technology for high ESD capability
- ◆ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high  $E_{AS}$
- ◆ Excellent package for good heat dissipation

## Application

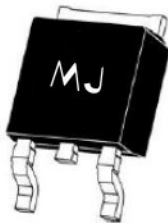
- ◆ Power switching application
- ◆ Hard switched and high frequency circuits
- ◆ Uninterruptible power supply



Schematic diagram



Marking and pin assignment



TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

## Package Marking and Ordering Information

| Device Marking | Device   | Device Package | Reel Size | Tape width | Quantity |
|----------------|----------|----------------|-----------|------------|----------|
| MJ0130KA       | MJ0130KA | TO-252-2L      | -         | -          | -        |

## Absolute Maximum Ratings (Tc =25 °Cunless otherwise noted)

| Parameter   | Symbol                | Limit      | Unit |
|---|-----------------------|------------|------|
| Drain-Source Voltage                              | $V_{DS}$              | 100        | V    |
| Gate-Source Voltage                               | $V_{GS}$              | ±20        | V    |
| Drain Current-Continuous                          | $I_D$                 | 30         | A    |
| Drain Current-Continuous( $T_C = 100^{\circ}C$ )  | $I_{D(100^{\circ}C)}$ | 21         | A    |
| Pulsed Drain Current <sup>(Note 1)</sup>          | $I_{DM}$              | 120        | A    |
| Maximum Power Dissipation                         | $P_D$                 | 85         | W    |
| Derating factor                                   |                       | 0.57       | W/°C |
| Single pulse avalanche energy <sup>(Note 5)</sup> | $E_{AS}$              | 200        | mJ   |
| Operating Junction and Storage Temperature Range  | $T_J, T_{STG}$        | -55 To 175 | °C   |

## Thermal Characteristic

|   |                 |     |      |
|---|-----------------|-----|------|
| Thermal Resistance,Junction-to-Case <sup>(Note 2)</sup> | $R_{\theta JC}$ | 1.8 | °C/W |
|---|-----------------|-----|------|

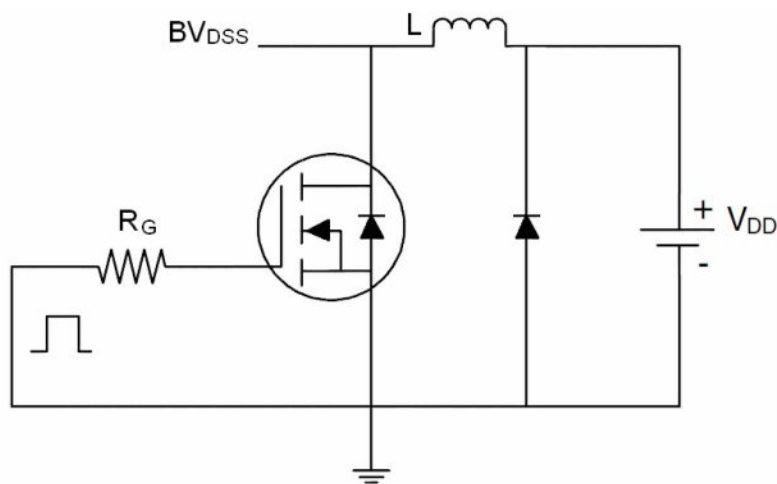
Electrical Characteristics (T<sub>c</sub> =25°Cunless otherwise noted)

| Parameter                                     | Symbol              | Condition   | Min | Typ  | Max  | Unit |
|---|---------------------|---|-----|------|------|------|
| Off Characteristics                           |                     |   |     |      |      |      |
| Drain-Source Breakdown Voltage                | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250μA   | 100 | 115  | -    | V    |
| Zero Gate Voltage Drain Current               | I <sub>DSS</sub>    | V <sub>DS</sub> =100V,V <sub>GS</sub> =0V   | -   | -    | 1    | μA   |
| Gate-Body Leakage Current                     | I <sub>GSS</sub>    | V <sub>DS</sub> =±20V,V <sub>GS</sub> =0V   | -   | -    | ±100 | nA   |
| On Characteristics <sup>(Note 3)</sup>        |                     |   |     |      |      |      |
| Gate Threshold Voltage                        | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA                               | 1.3 | 1.9  | 2.5  | V    |
| Drain-Source On-State Resistance              | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =10A   | -   | 25   | 32   | mΩ   |
| Forward Transconductance                      | g <sub>FS</sub>     | V <sub>DS</sub> =5V,I <sub>D</sub> =10A   | -   | 15   | -    | S    |
| Dynamic Characteristics <sup>(Note 4)</sup>   |                     |   |     |      |      |      |
| Input Capacitance                             | C <sub>iss</sub>    | V <sub>DS</sub> =50V,V <sub>GS</sub> =0V<br>F=1.0MHz                                  | -   | 2479 | -    | PF   |
| Output Capacitance                            | C <sub>oss</sub>    |   | -   | 96   | -    | PF   |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>    |   | -   | 79   | -    | PF   |
| Switching Characteristics <sup>(Note 4)</sup> |                     |   |     |      |      |      |
| Turn-on Delay Time                            | t <sub>d(on)</sub>  | V <sub>DD</sub> =50V, R <sub>L</sub> =5Ω<br>V <sub>GS</sub> =10V,R <sub>GEN</sub> =3Ω | -   | 9    | -    | nS   |
| Turn-on Rise Time                             | t <sub>r</sub>      |   | -   | 9    | -    | nS   |
| Turn-Off Delay Time                           | t <sub>d(off)</sub> |   | -   | 32   | -    | nS   |
| Turn-Off Fall Time                            | t <sub>f</sub>      |   | -   | 8    | -    | nS   |
| Total Gate Charge                             | Q <sub>g</sub>      | V <sub>DS</sub> =50V,I <sub>D</sub> =10A<br>V <sub>GS</sub> =10V                      | -   | 67.2 | -    | nC   |
| Gate-Source Charge                            | Q <sub>gs</sub>     |   | -   | 9.4  | -    | nC   |
| Gate-Drain Charge                             | Q <sub>gd</sub>     |   | -   | 15.5 | -    | nC   |
| Drain-Source Diode Characteristics            |                     |   |     |      |      |      |
| Diode Forward Voltage <sup>(Note 3)</sup>     | V <sub>SD</sub>     | V <sub>GS</sub> =0V,I <sub>S</sub> =10A   | -   | -    | 1.2  | V    |
| Diode Forward Current <sup>(Note 2)</sup>     | I <sub>S</sub>      |   | -   | -    | 30   | A    |
| Reverse Recovery Time                         | t <sub>rr</sub>     | T <sub>J</sub> =25°C, I <sub>F</sub> =10A<br>di/dt=100A/μs <sup>(Note 3)</sup>        | -   | 32   | -    | nS   |
| Reverse Recovery Charge                       | Q <sub>rr</sub>     |   | -   | 53   | -    | nC   |
| Forward Turn-On Time                          | t <sub>on</sub>     | Intrinsic turn-on time is negligible(turn-on is dominated by LS+LD)                   |     |      |      |      |

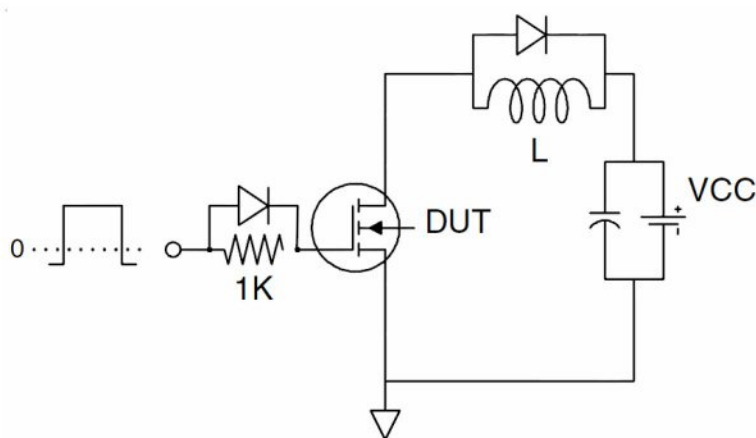
## Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
- ④ Guaranteed by design, not subject to production
- ⑤ EAS condition: T<sub>J</sub>=25°C,V<sub>DD</sub>=50V,V<sub>G</sub>=10V,L=0.5mH,R<sub>g</sub>=25Ω

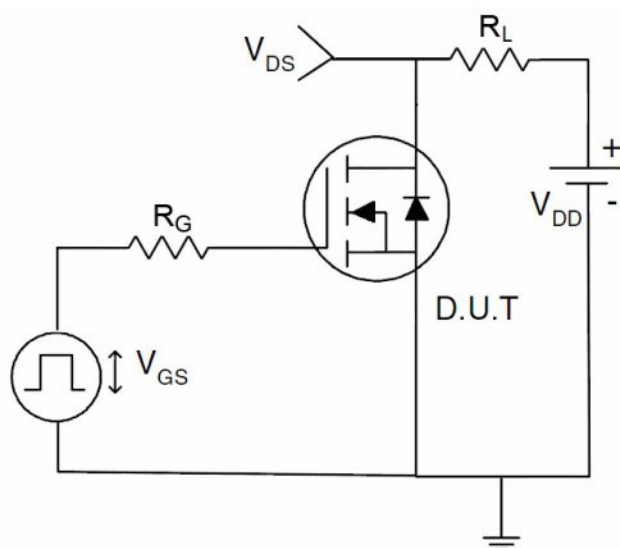
## Test circuit



EAS test Circuit

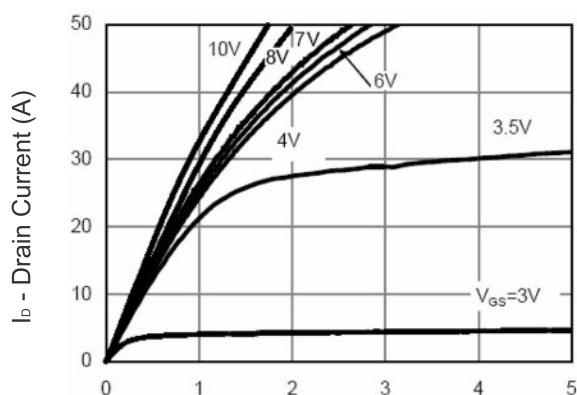


Gate charge test Circuit



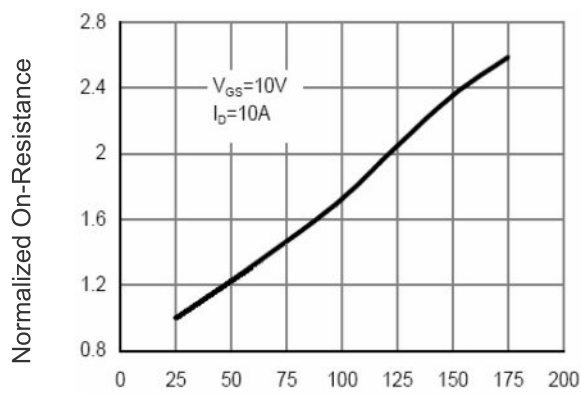
Switch Time Test Circuit

## Typical Electrical and Thermal Characteristics (Curves)



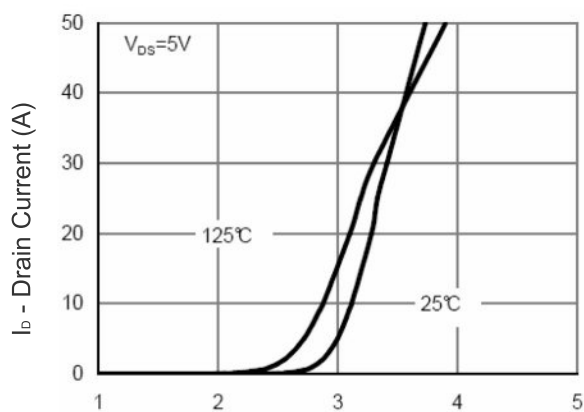
$V_{DS}$  Drain-Source Voltage (V)

Figure 1 Output Characteristics



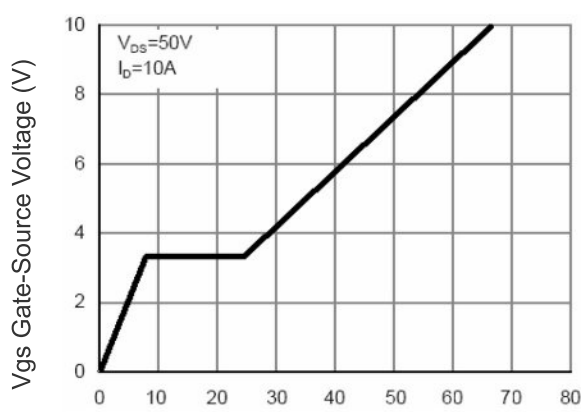
$T_J$  -Junction Temperature( $^{\circ}\text{C}$ )

Figure 4  $R_{DS(on)}$ -Junction Temperature



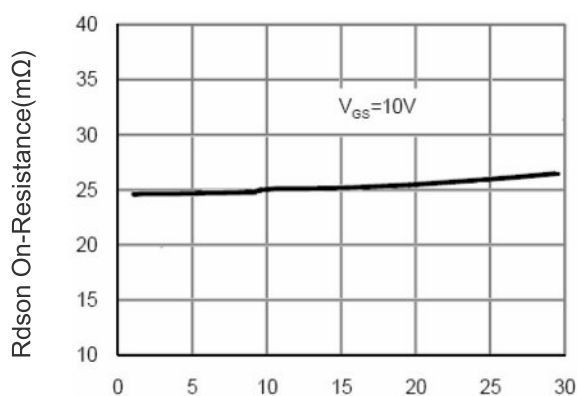
$V_{GS}$  Gate-Source Voltage (V)

Figure 2 Transfer Characteristics



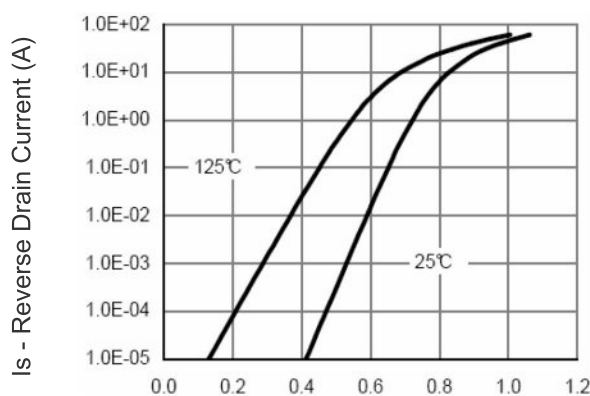
$Q_g$  Gate Charge (nC)

Figure 5 Gate Charge



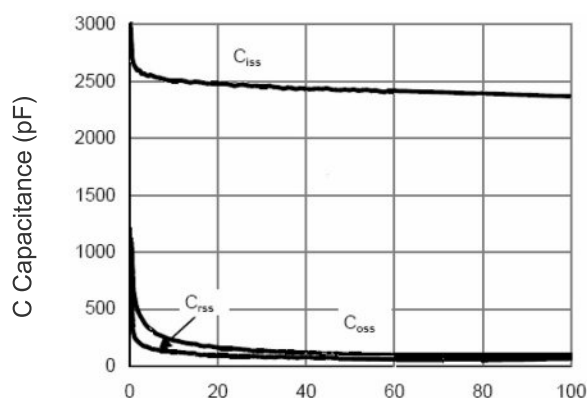
$I_D$  - Drain Current (A)

Figure 3  $R_{DS(on)}$ - Drain Current

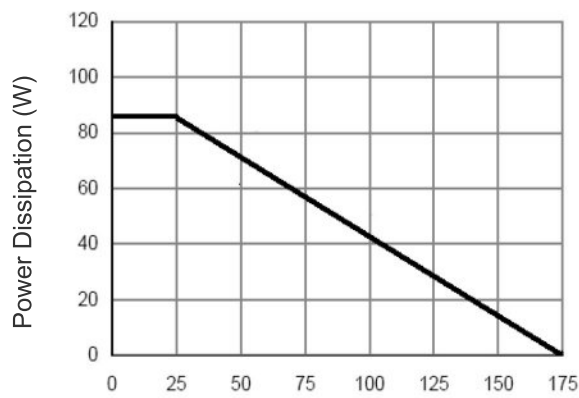


$V_{SD}$  Source-Drain Voltage (V)

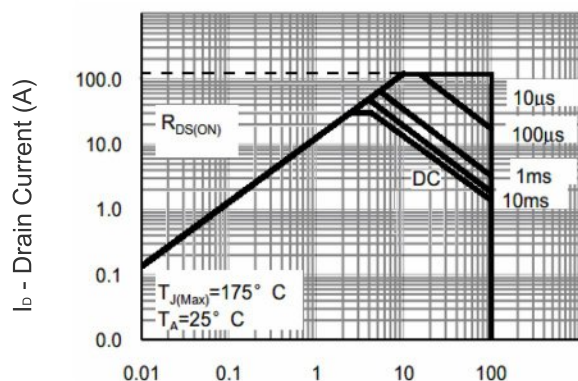
Figure 6 Source- Drain Diode Forward



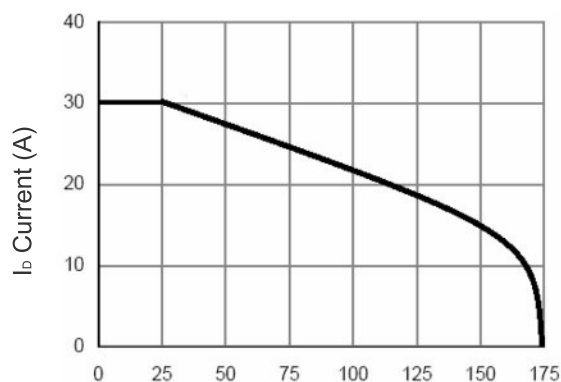
Vds Drain-Source Voltage (V)  
Figure 7 Capacitance vs Vds



TJ -Junction Temperature(°C)  
Figure 9 Power De-rating



Vds Drain-Source Voltage (V)  
Figure 8 Safe Operation Area



TJ -Junction Temperature(°C)  
Figure 10 Id Current- Junction Temperature

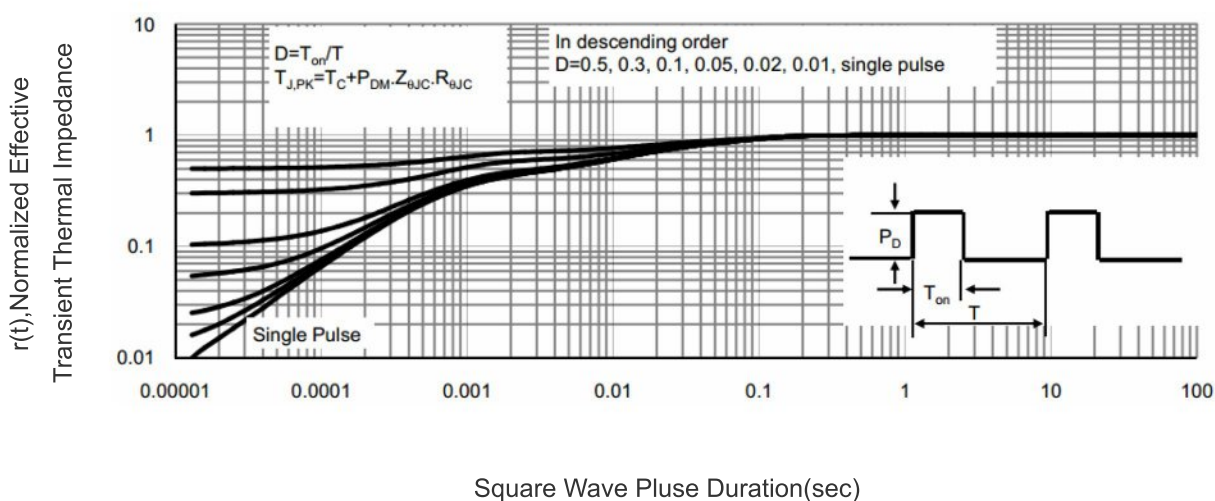
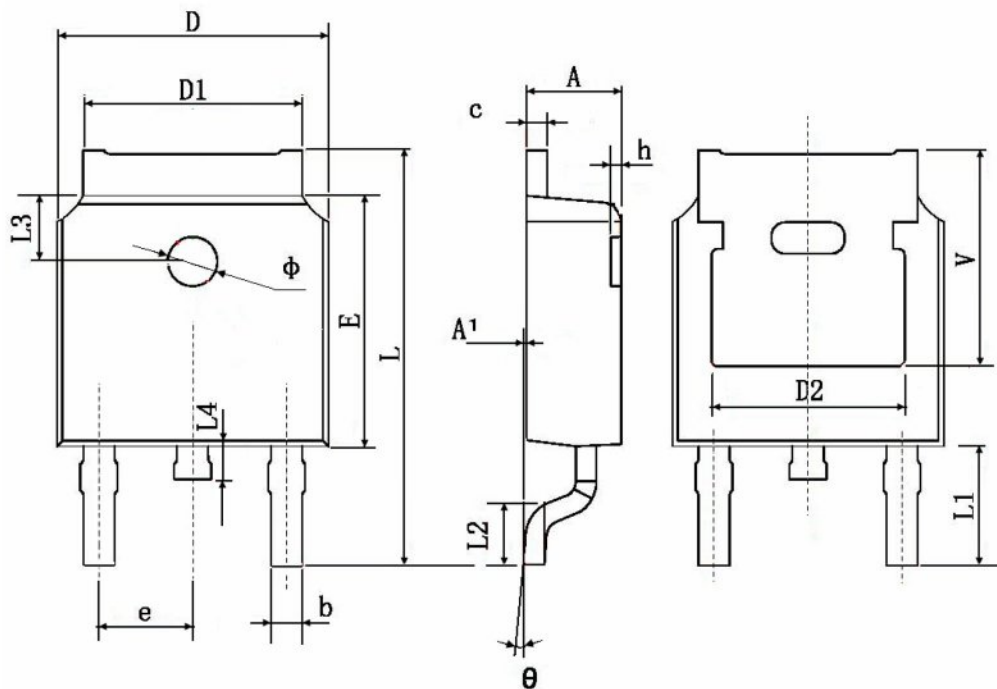


Figure 11 Normalized Maximum Transient Thermal Impedance

# TO-252 Package Information



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| A      | 2.200                     | 2.400  | 0.087                | 0.094 |
| A1     | 0.000                     | 0.127  | 0.000                | 0.005 |
| b      | 0.660                     | 0.860  | 0.026                | 0.034 |
| c      | 0.460                     | 0.580  | 0.018                | 0.023 |
| D      | 6.500                     | 6.700  | 0.256                | 0.264 |
| D1     | 5.100                     | 5.460  | 0.201                | 0.215 |
| D2     | 4.830 TYP.                |        | 0.190 TYP.           |       |
| E      | 6.000                     | 6.200  | 0.236                | 0.244 |
| e      | 2.186                     | 2.386  | 0.086                | 0.094 |
| L      | 9.800                     | 10.400 | 0.386                | 0.409 |
| L1     | 2.900 TYP.                |        | 0.114 TYP.           |       |
| L2     | 1.400                     | 1.700  | 0.055                | 0.067 |
| L3     | 1.600 TYP.                |        | 0.063 TYP.           |       |
| L4     | 0.600                     | 1.000  | 0.024                | 0.039 |
| Φ      | 1.100                     | 1.300  | 0.043                | 0.051 |
| θ      | 0°                        | 8°     | 0°                   | 8°    |
| h      | 0.000                     | 0.300  | 0.000                | 0.012 |
| V      | 5.350 TYP.                |        | 0.211 TYP.           |       |



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